

Checklist for thinfilm inquiry



Item	required	Remarks
Customer adress:		<u>Project name:</u>
		Sample
		Series
Material + Thickness (expl. Al2O3; 15mil)		
Requested quantity		
Customer files (GDS, DXF) with reference line		
Outer dimensions		
PDF-file of drawing		
Definition of conductive layers		
Gold Technology - Standard layer structure		
Top layer: TAN/TiW/AU		
Bottom layer: TiW/AU		
Extra request		
Copper Technology - Standard layer structure		
Top layer: NiCr/Ti/Cu/Ni/AU		
Bottom layer: /Ti/Cu/Ni/AU		
Extra request		
Tolerances of Structure		
Measurement point for line with tolerance		
Dicing line needed? >> bottom layer offset of 50µm		
Sheet resistance		
Trimming of resistor		
R-Tolerance		
Drilled holes / metalized / filled		
Packing style (Wafflepack)		
Additional requests		
For internal use		
RFQ-No.		
RFQ-Date		
Masks availability (quantity)		
CAD		
Article-No.		
Notes		
		Please mark the required processes!